DS16149,DS16179,DS36149,DS36179

DS16149 DS36149 DS16179 DS36179 Hex MOS Drivers

TEXAS INSTRUMENTS

Literature Number: SNOSBR3A

N *ational Semiconductor*

DS16149/DS36149, DS16179/DS36179 Hex MOS Drivers

General Description

The DS16149/DS36149 and DS16179/DS36179 are Hex MOS drivers with outputs designed to drive large capacitive loads up to 500 pF associated with MOS memory systems. PNP input transistors are employed to reduce input currents allowing the large fan-out to these drivers needed in memory systems. The circuit has Schottky-clamped transistor logic for minimum propagation delay, and a disable control that places the outputs in the logic "1" state (see truth table). This is especially useful in MOS RAM applications where a set of address lines has to be in the logic "1" state during refresh.

The DS16149/DS36149 has a 15 Ω resistor in series with the outputs to dampen transients caused by the fast-switching output. The DS16179/DS36179 has a direct low impedance output for use with or without an external resistor.

Features

- High speed capabilities
  - Typ 9 ns driving 50 pF
  - Typ 29 ns driving 500 pF
- Built-in 15 Ω damping resistor (DS16149/DS36149)
- Same pin-out as DM8096 and DM74366

Schematic Diagram
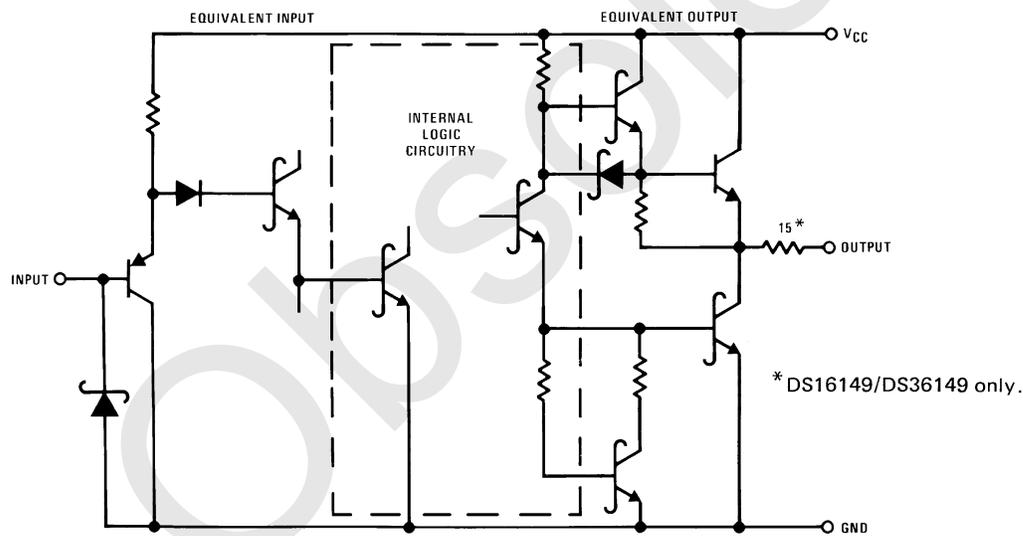
TL/F/7553–1

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7.0V
Logical "1" Input Voltage	7.0V
Logical "0" Input Voltage	−1.5V
Storage Temperature Range	−65°C to +150°C

Maximum Power Dissipation* at 25°C

Cavity Package	1371 mW
Molded Package	1280 mW
Lead Temperature (Soldering 10 seconds)	300°C

*Derate cavity package 9.1 mW/°C above 25°C; derate molded package 10.2 m/W°C above 25°C.

Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	4.5	5.5	V
Temperature (T_A)			
DS16149, DS16179	−55	+125	°C
DS36149, DS36179	0	+70	°C

DC Electrical Characteristics (Notes 2 and 3)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
$V_{IN}(1)$	Logical "1" Input Voltage			2.0			V
$V_{IN}(0)$	Logical "0" Input Voltage					0.8	V
$I_{IN}(1)$	Logical "1" Input Current	$V_{CC} = 5.5V$, $V_{IN} = 5.5V$			0.1	40	μA
$I_{IN}(0)$	Logical "0" Input Current	$V_{CC} = 5.5V$, $V_{IN} = 0.5V$			−50	−250	μA
V_{CLAMP}	Input Clamp Voltage	$V_{CC} = 4.5V$, $I_{IN} = -18$ mA			−0.75	−1.2	V
V_{OH}	Logical "1" Output Voltage (No Load)	$V_{CC} = 4.5V$, $I_{OH} = -10$ μA	DS16149/DS16179	3.4	4.3		V
			DS36149/DS36179	3.5	4.3		V
V_{OL}	Logical "0" Output Voltage (No Load)	$V_{CC} = 4.5V$, $I_{OL} = 10$ μA	DS16149/DS16179		0.25	0.4	V
			DS36149/DS36179		0.25	0.35	V
V_{OH}	Logical "1" Output Voltage (With Load)	$V_{CC} = 4.5V$, $I_{OH} = -1.0$ mA	DS16149	2.4	3.5		V
			DS16179	2.5	3.5		V
			DS36149	2.6	3.5		V
			DS36179	2.7	3.5		V
V_{OL}	Logical "0" Output Voltage (With Load)	$V_{CC} = 4.5V$, $I_{OL} = 20$ mA	DS16149		0.6	1.1	V
			DS16179		0.4	0.5	V
			DS36149		0.6	1.0	V
			DS36179		0.4	0.5	V
I_{ID}	Logical "1" Drive Current	$V_{CC} = 4.5V$, $V_{OUT} = 0V$, (Note 4)			−250		mA
I_{OD}	Logical "0" Drive Current	$V_{CC} = 4.5V$, $V_{OUT} = 4.5V$, (Note 4)			150		mA
I_{CC}	Power Supply Current	$V_{CC} = 5.5V$	Disable Inputs = 0V All Other Inputs = 3V		33	60	mA
			All Inputs = 0V	14		20	mA

Switching Characteristics ($V_{CC} = 5V$, $T_A = 25°C$) (Note 4)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
$t_{S\pm}$	Storage Delay Negative Edge	(*Figure 1*)	$C_L = 50$ pF		4.5	7	ns
			$C_L = 500$ pF		7.5	12	ns
$t_{S\mp}$	Storage Delay Positive Edge	(*Figure 1*)	$C_L = 50$ pF		5	8	ns
			$C_L = 500$ pF		8	13	ns
t_F	Fall Time	(*Figure 1*)	$C_L = 50$ pF		5	8	ns
			$C_L = 500$ pF		22	35	ns

Switching Characteristics $(V_{CC} = 5V, T_A = 25°C)$ (Note 4) (Continued)

| Symbol	Parameter	Conditions		Min	Typ	Max	Units
t_R	Rise Time	(Figure 1)	$C_L = 50$ pF		6	9	ns
			$C_L = 500$ pF		26	35	ns
t_{LH}	Delay from Disable Input to Logical "1"	$R_L = 2$ kΩ to Gnd, $C_L = 50$ pF, (Figure 2)			15	22	ns
t_{HL}	Delay from Disable Input to Logical "0"	$R_L = 2$ kΩ to V_{CC}, $C_L = 50$ pF, (Figure 3)			11	18	ns

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Unless otherwise specified min/max limits apply across the −55°C to +125°C temperature range for the DS16149 and DS16179 and across the 0°C to +70°C range for the DS36149 and DS36179. All typical values are for $T_A = 25°C$ and $V_{CC} = 5V$.

Note 3: All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

Note 4: When measuring output drive current and switching response for the DS16179 and DS36179 a 15 Ω resistor should be placed in series with each output. This resistor is internal to the DS16149/DS36149 and need not be added.

Connection Diagram

Dual In-Line Package

TL/F/7553–2
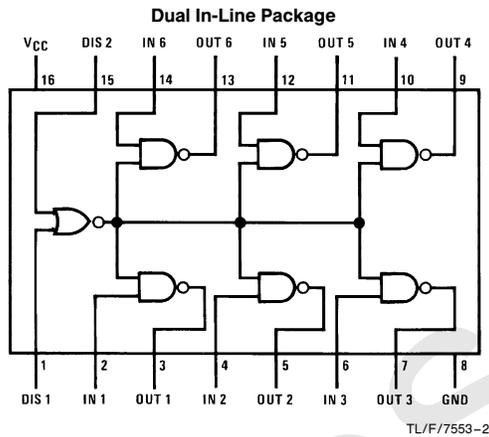
Top View

Order Number DS16149J, DS36149J, DS16179J, DS36179J, DS36149N or DS36179N
See NS Package Number J16A or N16A

Truth Table

Disable Input		Input	Output
DIS 1	DIS2		
0	0	0	1
0	0	1	0
0	1	X	1
1	0	X	1
1	1	X	1

X = Don't care

AC Test Circuits and Switching Time Waveforms

$t_{S±}, t_{S±}, t_R, t_F$
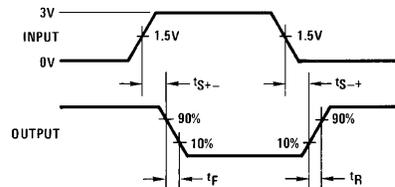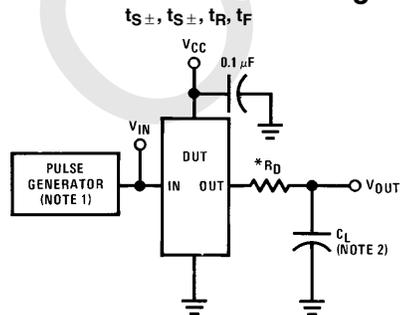
TL/F/7553–3

FIGURE 1

3

AC Test Circuits and Switching Time Waveforms (Continued)
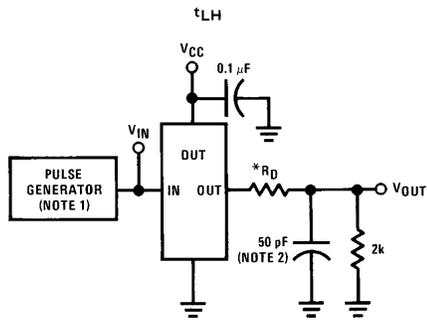
FIGURE 2
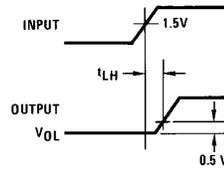
TL/F/7553-4
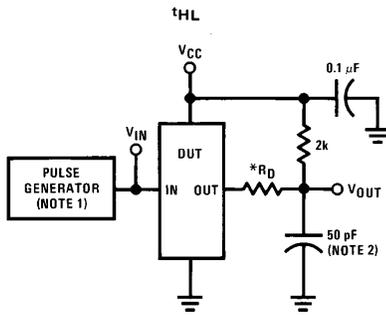
FIGURE 3
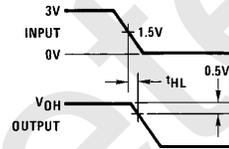
TL/F/7553-5

*Internal on DS16149 and DS36149

Note 1: The pulse generator has the following characteristics: $Z_{OUT} = 50\ \Omega$ and PRR $\leq$ 1 MHz. Rise and fall times between 10% and 90% points $\leq$ 5 ns.

Note 2: C_L includes probe and jig capacitance.

Typical Applications

TL/F/7553-6

4

Physical Dimensions inches (millimeters)

0.785
[19.94] MAX

16   9

0.220-0.310
[5.59-7.87]

R 0.025
[0.64]

1   8

R 0.005-0.020
[0.13-0.51] TYP

0.037 ± 0.005
[0.94 ± 0.13] TYP

0.005
[0.13]
MIN TYP

0.055 ± 0.005
[1.40 ± 0.13] TYP

0.200
[5.08]
MAX TYP

0.020-0.060
[0.51-1.52] TYP

0.150
[3.81] MIN TYP

0.125-0.200
[3.18-5.08] TYP

90° ± 4°
TYP

0.080
[2.03] MAX
BOTH ENDS

0.018 ± 0.003
[0.46 ± 0.08] TYP

0.100 ± 0.010
[2.54 ± 0.25] TYP

0.290-0.320
[7.37-8.13]

GLASS SEALANT

0.180
[4.57] MAX

0.010 ± 0.002
[0.25 ± 0.05] TYP

95° ± 5°
TYP

0.310-0.410
[7.87-10.41]
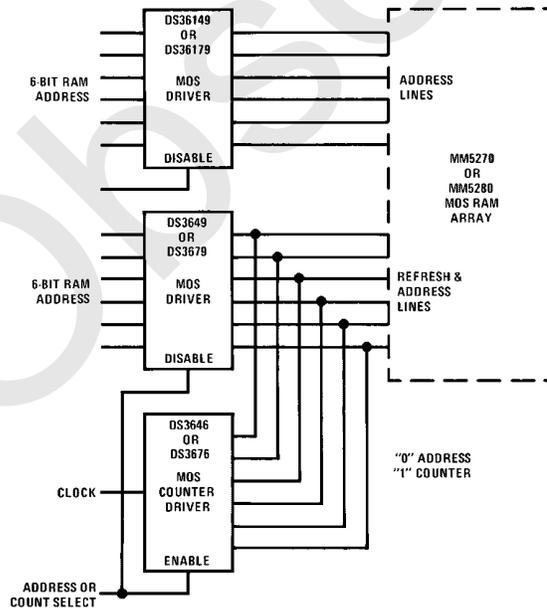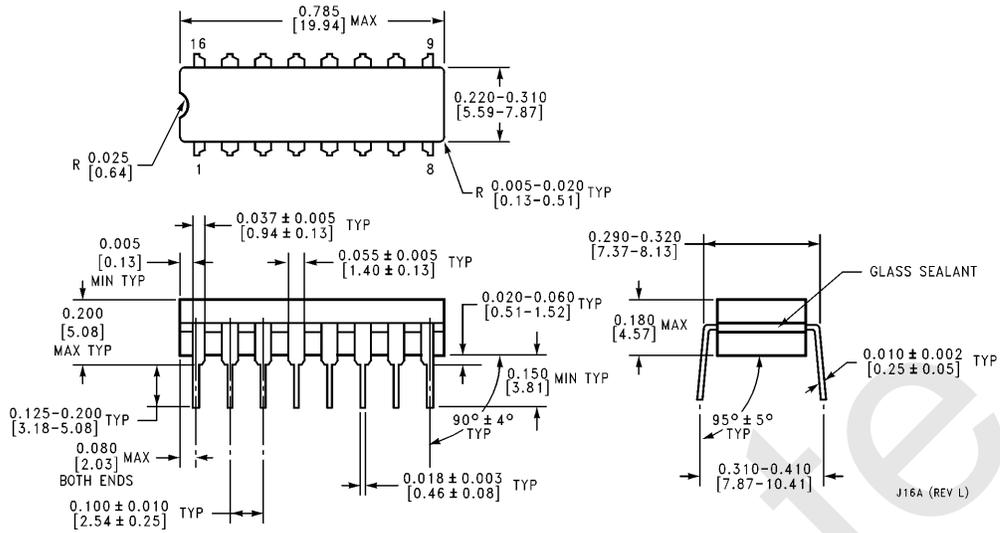
J16A (REV L)

Ceramic Dual-In-Line Package (J)
Order Number DS16149J, DS36149J
DS16179J or DS36179J
NS Package Number J16A

Physical Dimensions inches (millimeters) (Continued)

0.092
(2.337)
DIA NOM
(2X)

PIN NO. 1 IDENT

0.090
(2.286)
NOM

0.843–0.870
(21.41–22.10)

0.250 ±0.005
(6.350 ±0.127)

0.280
(7.112)
MIN

0.030
(0.762)
MAX

0.300–0.320
(7.620–8.128)

95° ±5°

0.009–0.015
(0.229–0.381)

0.325 +0.040 −0.015
(8.255 +1.016 −0.381)

0.065
(1.651)

0.060
(1.524)

0.040
(1.016)
TYP

0.130 ±0.005
(3.302 ±0.127)

0.145–0.200
(3.683–5.080)

90° ±4°
TYP

0.020
(0.508)
MIN

0.075 ±0.015
(1.905 ±0.381)

0.018 ±0.003
(0.457 ±0.076)

0.125–0.140
(3.175–3.556)

0.100 ±0.010
(2.540 ±0.254)
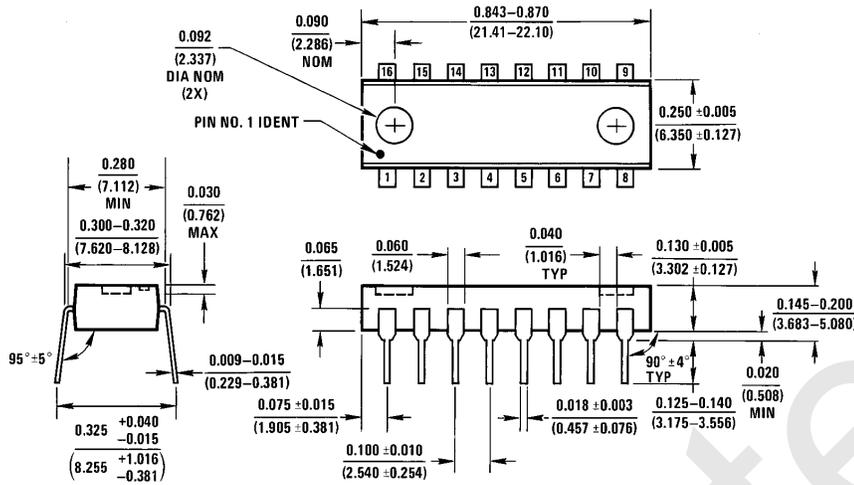
N16A (REV E)

Molded Dual-In-Line Package (N)
Order Number DS36149N, DS36149N
NS Package Number N16A

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